





HALF-BRIDGE GATE DRIVER IN SO-8

Description

The DGD2104M is a high-voltage / high-speed gate driver capable of driving N-channel MOSFETs and IGBTs in a half bridge configuration. High-voltage processing techniques enable the DGD2104M's high side to switch to 600V in a bootstrap operation.

The DGD2104M logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high-pulse current buffers designed for minimum driver cross conduction.

The DGD2104M is offered in the SO-8 package and operates over an extended -40 $^{\circ}$ C to +125 $^{\circ}$ C temperature range.

Applications

- DC-DC Converters
- DC-AC Inverters
- AC-DC Power Supplies
- Motor Controls
- Class D Power Amplifiers

Vcc Vc Vs IN DGD2104M Vs COM LO

Typical Configuration

Features

- Floating High-Side Driver in Bootstrap Operation to 600V
- Drives Two N-Channel MOSFETs or IGBTs in a Half Bridge Configuration
- 290mA Source / 600mA Sink Output Current Capability
- Designed for Enhanced Performance in Noisy Motor Applications
- Outputs Tolerant to Negative Transients
- Internal Dead Time to Protect MOSFETs
- Wide Low-Side Gate Driver Supply Voltage: 10V to 20V
- Logic Input (IN and SD*) 3.3V Capability
- Schmitt Triggered Logic Inputs
- Undervoltage Lockout for Vcc (Logic and Low Side Supply)
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SO-8 (Standard)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Top View

Ordering Information (Note 4)

Part Number	Marking	Reel Size (inch)	Tape Width (mm)	Quantity per Reel	
DGD2104MS8-13	DGD2104M	13	12	2,500	

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

Up to 600V

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

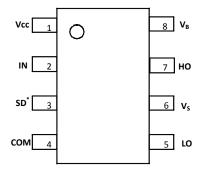
Marking Information



⊃¦¦ = Manufacturer's Marking DGD2104M = Product Type Marking Code YY = Year (ex: 21 = 2021) WW or WW− = Week (01 to 53)



Pin Diagrams

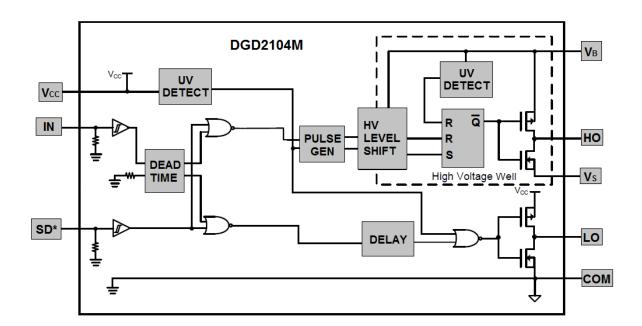


Top View: SO-8

Pin Descriptions

Pin Number	Pin Name	Function
1	Vcc	Logic and Low Side Supply
2	IN	Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO
3	SD*	Logic input for Shutdown, Enabled Low
4	COM	Low-Side and Logic Return
5	LO	Low-Side Gate Drive Output
6	Vs	High-Side Floating Supply Return
7	НО	High-Side Gate Drive Output
8	V _B	High-Side Floating Supply

Functional Block Diagram





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	V _B	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V _B -24 to V _B +0.3	V
High-Side Floating Output Voltage	VHO	Vs-0.3 to V _B +0.3	V
Offset Supply Voltage Transient	dV _S / dt	50	V/ns
Low-Side Fixed Supply Voltage	V _{CC}	-0.3 to +24	V
Low-Side Output Voltage	V _{LO}	-0.3 to V _{CC} +0.3	V
Logic Input Voltage (IN and SD*)	V _{IN}	-0.3 to Vcc+0.3	V

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	P _D	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	200	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	Tstg	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	V _B	Vs + 10	Vs + 20	V
High Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High Side Floating Output Voltage	VHO	Vs	V _B	V
Low Side Fixed Supply Voltage	Vcc	10	20	V
Low Side Output Voltage	V _{LO}	0	Vcc	V
Logic Input Voltage (IN and SD*)	V _{IN}	0	5	V
Ambient Temperature	T _A	-40	+125	°C

Note: 6. Logic operation for Vs of -5V to +600V.



DC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, @T_A = +25°C, unless otherwise specified.) (Note 7)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Logic "1" (IN) & Logic "0" (SD*) Input Voltage	ViH	2.5	_	_	V	Vcc = 10V to 20V
Logic "0" (IN) & Logic "1" (SD*) Input Voltage	VIL	-	_	0.8	V	Vcc = 10V to 20V
High Level Output Voltage, VBIAS - VO	Vон	_	0.05	0.2	V	$I_0 = 2mA$
Low Level Output Voltage, Vo	Vol	_	0.02	0.1	V	$I_0 = 2mA$
Offset Supply Leakage Current	I _{LK}	_	_	50	μΑ	$V_B = V_S = 600V$
Quiescent V _{BS} Supply Current	I _{BSQ}	_	60	100	μΑ	$V_{IN} = 0V \text{ or } 5V$
Quiescent Vcc Supply Current	Iccq ₁	ı	350	500	μΑ	$V_{IN} = 0V \text{ or } 5V, SD^* = 5V$
Quiescent V _{CC} Supply Current in Shutdown	IccQ2	ı	590	750	μΑ	$V_{IN} = 0V \text{ or } 5V, SD^* = 0V$
Logic "1" Input Bias Current	I _{IN+}	_	3.0	10	μΑ	$V_{IN} = 5V, SD^* = 0V$
Logic "0" Input Bias Current	I _{IN} -	ı	_	5.0	μΑ	$V_{IN} = 0V, SD^* = 5V$
Vcc Supply Undervoltage Positive Going Threshold	Vccuv+	8.0	8.9	9.8	V	_
Vcc Supply Undervoltage Negative Going Threshold	Vccuv-	7.4	8.2	9.0	V	_
V _{BS} Supply Undervoltage Positive Going Threshold	V _{BSUV+}	4.5	5.5	6.5	V	_
V _{BS} Supply Undervoltage Negative Going Threshold	V _{BSUV} -	4.2	5.2	6.2	V	_
Output High Short Circuit Pulsed Current	I _{O+}	130	290	_	mA	V _O = 0V, PW ≤ 10μs
Output Low Short Circuit Pulsed Current	lo-	270	600	_	mA	V _O = 15V, PW ≤ 10μs

Notes: 7. The V_{IN} and I_{IN} parameters are applicable to the two logic pins: IN and SD*. The V_O and I_O parameters are applicable to the respective output pins: HO and LO.

AC Electrical Characteristics (VBIAS (VCC, VBS) = 15V, CL = 1000pF, @TA = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Turn-On Propagation Delay	ton	_	680	820	ns	Vs = 0V
Turn-Off Propagation Delay	toff	_	150	220	ns	V _S = 600V
Shutdown Propagation Delay	tsp	_	160	220	ns	_
Delay Matching, HO and LO Turn-On / Turn-Off	tом	_	_	60	ns	_
Turn-On Rise Time	tr	_	70	170	ns	Vs = 0V
Turn-Off Fall Time	tr	_	35	90	ns	Vs = 0V
Deadtime: t _{DT LO-HO} & t _{DT HO-LO}	t _{DT}	300	420	650	ns	_



Timing Waveforms

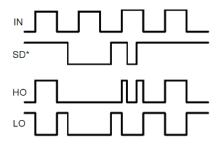


Figure 1. Input / Output Timing Diagram

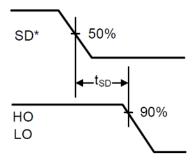


Figure 2. Shutdown Waveform Definition

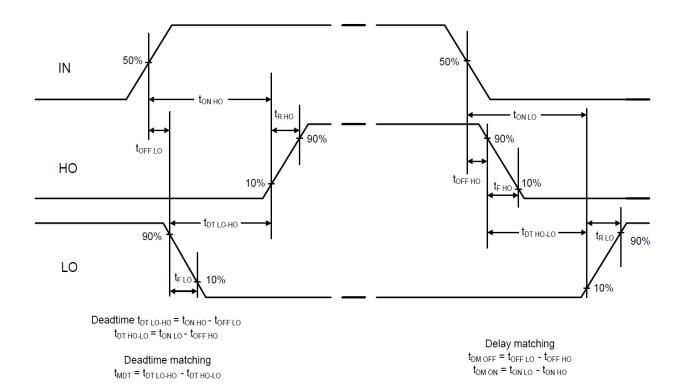


Figure 3. Switching Time Waveform Definitions



Typical Performance Characteristics (Vcc = 15V, @TA = +25°C, unless otherwise specified.)

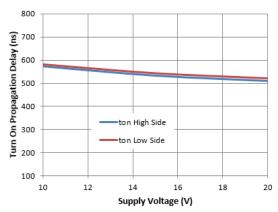
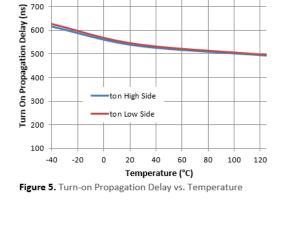


Figure 4. Turn-on Propagation Delay vs. Supply Voltage



800

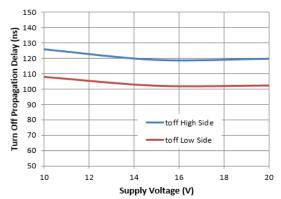


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

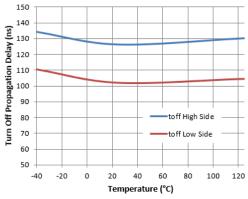


Figure 7. Turn-off Propagation Delay vs. Temperature

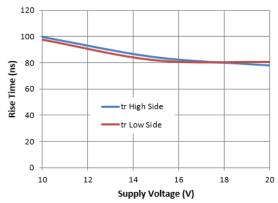


Figure 8. Rise Time vs. Supply Voltage

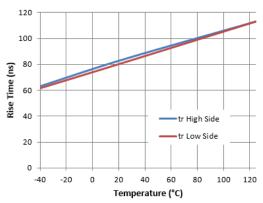


Figure 9. Rise Time vs. Temperature



Typical Performance Characteristics (continued)

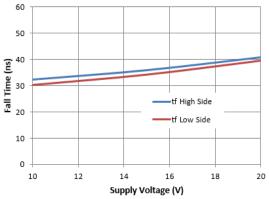


Figure 10. Fall Time vs. Supply Voltage

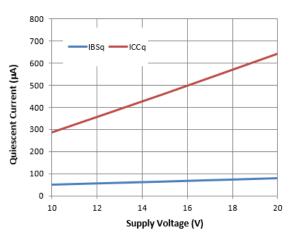


Figure 12. Quiescent Current vs. Supply Voltage

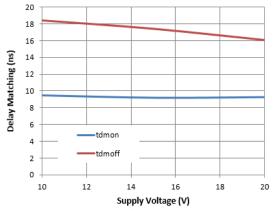


Figure 14. Delay Matching vs. Supply Voltage

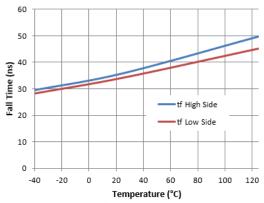


Figure 11. Fall Time vs. Temperature

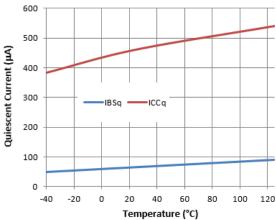


Figure 13. Quiescent Current vs. Temperature

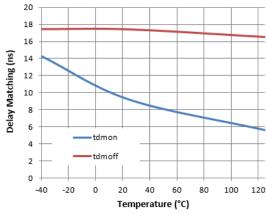


Figure 15. Delay Matching vs. Temperature



Typical Performance Characteristics (continued)

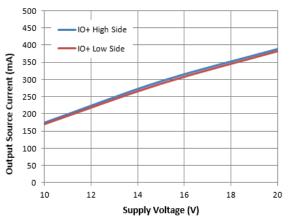


Figure 16. Output Source Current vs. Supply Voltage

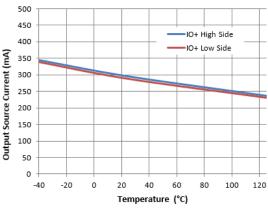


Figure 17. Output Source Current vs. Temperature

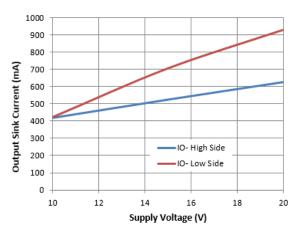


Figure 18. Output Sink Current vs. Supply Voltage

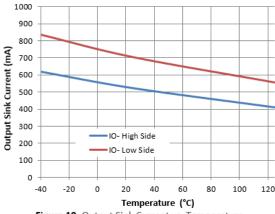


Figure 19. Output Sink Current vs. Temperature

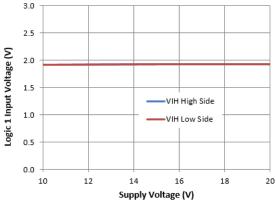


Figure 20. Logic 1 Input Voltage vs. Supply Voltage

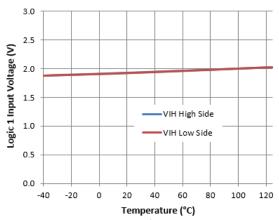


Figure 21. Logic 1 Input Voltage vs. Temperature



Typical Performance Characteristics (continued)

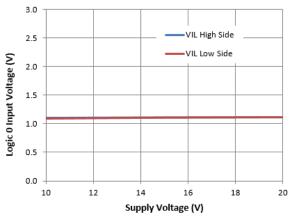


Figure 22. Logic O Input Voltage vs. Supply Voltage

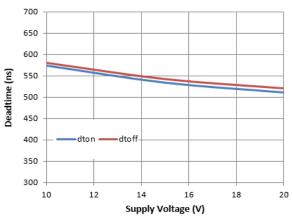


Figure 24. Deadtime vs. Supply Voltage

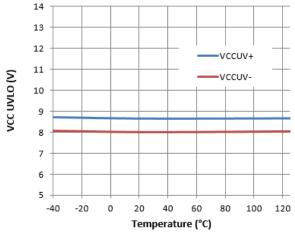


Figure 26. VCC UVLO vs. Temperature

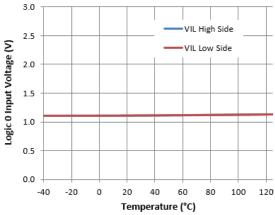


Figure 23. Logic 0 Input Voltage vs. Temperature

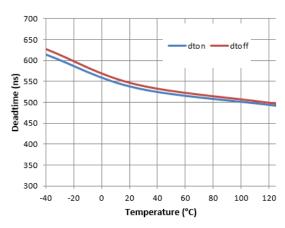


Figure 25. Deadtime vs. Temperature

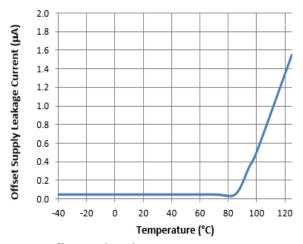


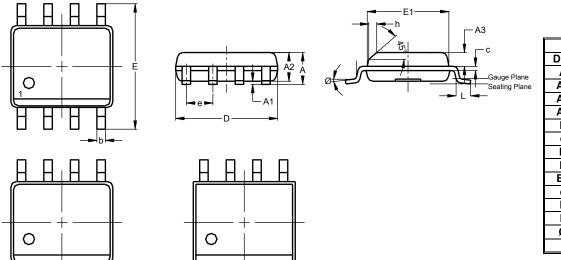
Figure 27. Offset Supply Leakage Current vs. Temperature



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Standard)



OPTION B

(TOP VIEW)

SO-8 (Standard)				
Dim	Min	Max	Тур	
Α		1.75		
A1	0.10	0.25		
A2	1.25	1.65		
A3	0.50	0.70		
b	0.30	0.51		
С	0.15	0.25		
D	4.80	5.00		
Е	5.80	6.20	6.00	
E1	3.80	4.00		
е			1.27	
h	0.25	0.50		
L	0.45	0.82		
Ø	0°	8°		
All Dimensions in mm				

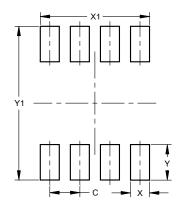
Suggested Pad Layout

OPTION A

(TOP VIEW)

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Standard)



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
Y1	6.50

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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